

DATA SHEET

74LV241

Octal buffer/line driver (3-State)

Product specification
Supersedes data of 1997 Feb 19
IC24 Data Handbook

1998 May 20

Octal buffer/line driver (3-State)

74LV241

FEATURES

- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7\text{ V}$ and $V_{CC} = 3.6\text{ V}$
- Typical V_{OLP} (output ground bounce) $< 0.8\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_{amb} = 25^\circ\text{C}$
- Typical V_{OHV} (output V_{OH} undershoot) $> 2\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_{amb} = 25^\circ\text{C}$
- Output capability: bus driver
- I_{CC} category: MSI

DESCRIPTION

The 74LV241 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT241.

The 74LV241 is an octal non-inverting buffer/line driver with 3-State outputs. The 3-State outputs are controlled by the output enable inputs $1\overline{OE}$ and $2OE$.

QUICK REFERENCE DATA

$GND = 0\text{ V}$; $T_{amb} = 25^\circ\text{C}$; $t_r = t_f \leq 2.5\text{ ns}$

| SYMBOL | PARAMETER | CONDITIONS | TYPICAL | UNIT |
|-------------------|---|--|---------|------|
| t_{PHL}/t_{PLH} | Propagation delay $1A_n$ to $1Y_n$; $2A_n$ to $2Y_n$ | $C_L = 15\text{ pF}$; $V_{CC} = 3.3\text{ V}$ | 8.0 | ns |
| C_I | Input capacitance | | 3.5 | pF |
| C_{PD} | Power dissipation capacitance per buffer | $V_{CC} = 3.3\text{ V}$ $V_I = GND$ to V_{CC}^1 | 30 | pF |

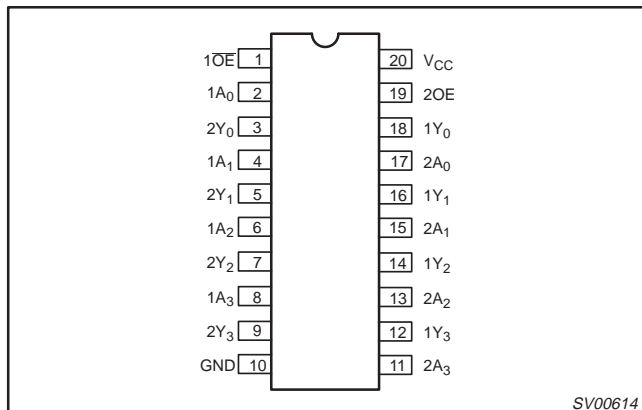
NOTE:

- C_{PD} is used to determine the dynamic power dissipation (P_D in μW)
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; C_L = output load capacitance in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

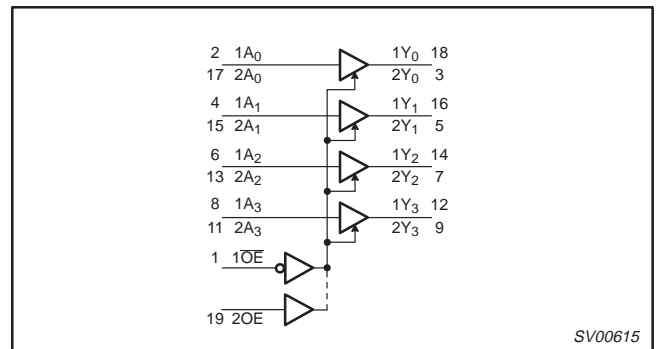
ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | PKG. DWG. # |
|-----------------------------|---|-----------------------|---------------|-------------|
| 20-Pin Plastic DIL | -40°C to $+125^\circ\text{C}$ | 74LV241 N | 74LV241 N | SOT146-1 |
| 20-Pin Plastic SO | -40°C to $+125^\circ\text{C}$ | 74LV241 D | 74LV241 D | SOT163-1 |
| 20-Pin Plastic SSOP Type II | -40°C to $+125^\circ\text{C}$ | 74LV241 DB | 74LV241 DB | SOT339-1 |
| 20-Pin Plastic TSSOP Type I | -40°C to $+125^\circ\text{C}$ | 74LV241 PW | 74LV241PW DH | SOT360-1 |

PIN CONFIGURATION



LOGIC SYMBOL



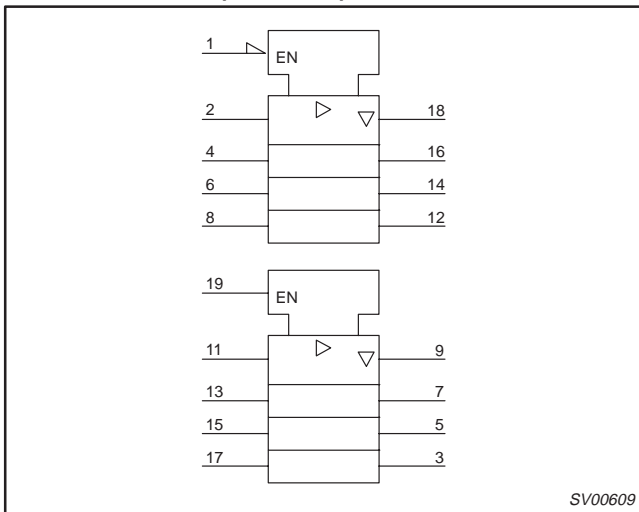
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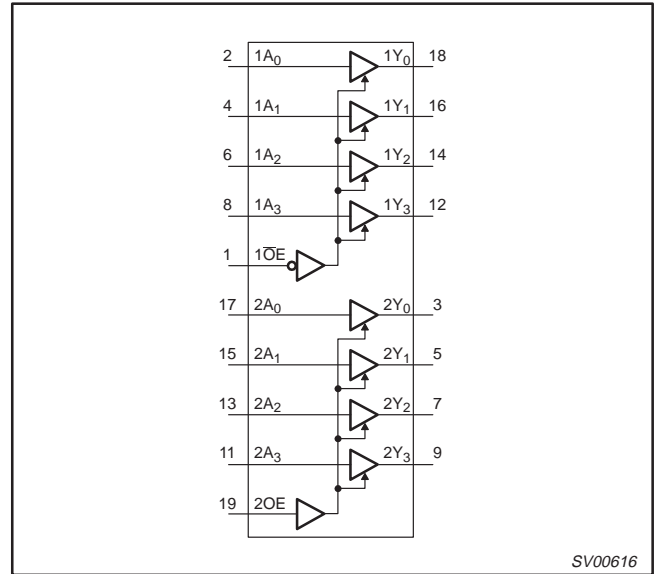
PIN DESCRIPTION

| PIN NUMBER | SYMBOL | FUNCTION |
|----------------|------------------|-----------------------------------|
| 1 | $1\overline{OE}$ | Output enable input (active LOW) |
| 2, 4, 6, 8 | $1A_0$ to $1A_3$ | Data inputs |
| 3, 5, 7, 9 | $2Y_0$ to $2Y_3$ | Bus outputs |
| 10 | GND | Ground (0 V) |
| 17, 15, 13, 11 | $2A_0$ to $2A_3$ | Data inputs |
| 18, 16, 14, 12 | $1Y_0$ to $1Y_3$ | Bus outputs |
| 19 | $2OE$ | Output enable input (active HIGH) |
| 20 | V_{CC} | Positive supply voltage |

LOGIC SYMBOL (IEEE/IEC)



FUNCTIONAL DIAGRAM



FUNCTION TABLE

| INPUTS | | | OUTPUT | | |
|------------------|--------|-------|--------|--------|--------|
| $1\overline{OE}$ | $1A_n$ | $2OE$ | $2A_n$ | $1Y_n$ | $2Y_n$ |
| L | L | H | L | H | L |
| L | H | H | H | L | H |
| H | X | L | X | Z | Z |

NOTES:

- H = HIGH voltage level
- L = LOW voltage level
- X = don't care
- Z = high impedance OFF-state

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RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNIT |
|------------|---|---|-------------|-------------|-------------------|------|
| V_{CC} | DC supply voltage | See Note 1 | 1.0 | 3.3 | 3.6 | V |
| V_I | Input voltage | | 0 | – | V_{CC} | V |
| V_O | Output voltage | | 0 | – | V_{CC} | V |
| T_{amb} | Operating ambient temperature range in free air | See DC and AC characteristics | –40 –40 | | +85 +125 | °C |
| t_r, t_f | Input rise and fall times | $V_{CC} = 1.0V$ to $2.0V$ $V_{CC} = 2.0V$ to $2.7V$ $V_{CC} = 2.7V$ to $3.6V$ | – – – | – – – | 500 200 100 | ns/V |

NOTE:

1. The LV is guaranteed to function down to $V_{CC} = 1.0V$ (input levels GND or V_{CC}); DC characteristics are guaranteed from $V_{CC} = 1.2V$ to $V_{CC} = 3.6V$.

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0V).

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|--------------------------------|--|---|-------------------|------|
| V_{CC} | DC supply voltage | | –0.5 to +4.6 | V |
| $\pm I_{IK}$ | DC input diode current | $V_I < -0.5$ or $V_I > V_{CC} + 0.5V$ | 20 | mA |
| $\pm I_{OK}$ | DC output diode current | $V_O < -0.5$ or $V_O > V_{CC} + 0.5V$ | 50 | mA |
| $\pm I_O$ | DC output source or sink current – bus driver outputs | $-0.5V < V_O < V_{CC} + 0.5V$ | 35 | mA |
| $\pm I_{GND},$ $\pm I_{CC}$ | DC V_{CC} or GND current for types with –bus driver outputs | | 70 | mA |
| T_{stg} | Storage temperature range | | –65 to +150 | °C |
| P_{tot} | Power dissipation per package –plastic DIL –plastic mini-pack (SO) –plastic shrink mini-pack (SSOP and TSSOP) | for temperature range: –40 to +125°C above +70°C derate linearly with 12mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K | 750 500 400 | mW |

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC CHARACTERISTICS FOR THE LV FAMILY

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | | | UNIT |
|------------------|---|---|----------------|------------------|------|-----------------|------|------|
| | | | -40°C to +85°C | | | -40°C to +125°C | | |
| | | | MIN | TYP ¹ | MAX | MIN | MAX | |
| V _{IH} | HIGH level Input voltage | V _{CC} = 1.2V | 0.9 | | | 0.9 | | V |
| | | V _{CC} = 2.0V | 1.4 | | | 1.4 | | |
| | | V _{CC} = 2.7 to 3.6V | 2.0 | | | 2.0 | | |
| V _{IL} | LOW level Input voltage | V _{CC} = 1.2V | | | 0.3 | | 0.3 | V |
| | | V _{CC} = 2.0V | | | 0.6 | | 0.6 | |
| | | V _{CC} = 2.7 to 3.6V | | | 0.8 | | 0.8 | |
| V _{OH} | HIGH level output voltage; all outputs | V _{CC} = 1.2V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA | | 1.2 | | | | V |
| | | V _{CC} = 2.0V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA | 1.8 | 2.0 | | 1.8 | | |
| | | V _{CC} = 2.7V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA | 2.5 | 2.7 | | 2.5 | | |
| | | V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; -I _O = 100μA | 2.8 | 3.0 | | 2.8 | | |
| V _{OH} | HIGH level output voltage; BUS driver outputs | V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; -I _O = 8mA | 2.40 | 2.82 | | 2.20 | | V |
| V _{OL} | LOW level output voltage; all outputs | V _{CC} = 1.2V; V _I = V _{IH} or V _{IL} ; I _O = 100μA | | 0 | | | | V |
| | | V _{CC} = 2.0V; V _I = V _{IH} or V _{IL} ; I _O = 100μA | | 0 | 0.2 | | 0.2 | |
| | | V _{CC} = 2.7V; V _I = V _{IH} or V _{IL} ; I _O = 100μA | | 0 | 0.2 | | 0.2 | |
| | | V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = 100μA | | 0 | 0.2 | | 0.2 | |
| V _{OL} | LOW level output voltage; BUS driver outputs | V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = 8mA | | 0.20 | 0.40 | | 0.50 | V |
| I _I | Input leakage current | V _{CC} = 3.6V; V _I = V _{CC} or GND | | | 1.0 | | 1.0 | μA |
| I _{OZ} | 3-State output OFF-state current | V _{CC} = 3.6V; V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND | | | 5 | | 10 | μA |
| I _{CC} | Quiescent supply current; MSI | V _{CC} = 3.6V; V _I = V _{CC} or GND; I _O = 0 | | | 20.0 | | 160 | μA |
| ΔI _{CC} | Additional quiescent supply current per input | V _{CC} = 2.7V to 3.6V; V _I = V _{CC} - 0.6V | | | 500 | | 850 | μA |

NOTE:1. All typical values are measured at T_{amb} = 25°C.

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AC CHARACTERISTICS

GND = 0V; $t_r = t_f \leq 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 1\text{K}\Omega$

| SYMBOL | PARAMETER | WAVEFORM | CONDITION | LIMITS | | | | | UNIT |
|------------------------------------|---|--------------|------------|---------------------|-----------------|------------------|----------------|-----|------|
| | | | | -40 to +85 °C | | | -40 to +125 °C | | |
| | | | | V _{CC} (V) | MIN | TYP ¹ | MAX | MIN | |
| t _{PHL} /t _{PLH} | Propagation delay 1A _n to 1Y _n ; 2A _n to 2Y _n | Figures 1 | 1.2 | | 45 | | | | ns |
| | | | 2.0 | | 15 | 31 | | 36 | |
| | | | 2.7 | | 11 | 23 | | 26 | |
| | | | 3.0 to 3.6 | | 9 ² | 18 | | 21 | |
| t _{PZH} /t _{PZL} | 3-State output enable time 1OE to 1Y _n ; 2OE to 2Y _n | Figures 2, 3 | 1.2 | | 55 | | | | ns |
| | | | 2.0 | | 19 | 36 | | 44 | |
| | | | 2.7 | | 14 | 26 | | 33 | |
| | | | 3.0 to 3.6 | | 10 ² | 21 | | 26 | |
| t _{PHZ} /t _{PLZ} | 3-State output disable time 1OE to 1Y _n ; 2OE to 2Y _n | Figures 2, 3 | 1.2 | | 60 | | | | ns |
| | | | 2.0 | | 22 | 39 | | 48 | |
| | | | 2.7 | | 17 | 29 | | 36 | |
| | | | 3.0 to 3.6 | | 13 ² | 24 | | 29 | |

NOTES:

1. Unless otherwise stated, all typical values are measured at T_{amb} = 25°C.
2. Typical values are measured at V_{CC} = 3.3 V.

AC WAVEFORMS

V_M = 1.5 V at V_{CC} ≥ 2.7 V; V_M = 0.5 V × V_{CC} at V_{CC} < 2.7 V
 V_X = V_{OL} + 0.3 V at V_{CC} ≥ 2.7 V; V_X = V_{OL} + 0.1 V × V_{CC} at V_{CC} < 2.7 V
 V_Y = V_{OH} - 0.3 V at V_{CC} ≥ 2.7V; V_Y = V_{OH} - 0.1 × V_{CC} at V_{CC} < 2.7 V
 V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

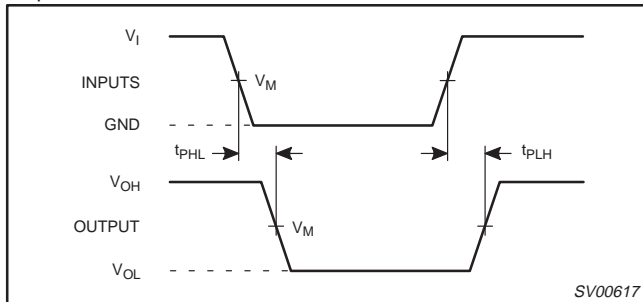


Figure 1. Input (1A_n, 2A_n) to output (1Y_n, 2Y_n) propagation delays.

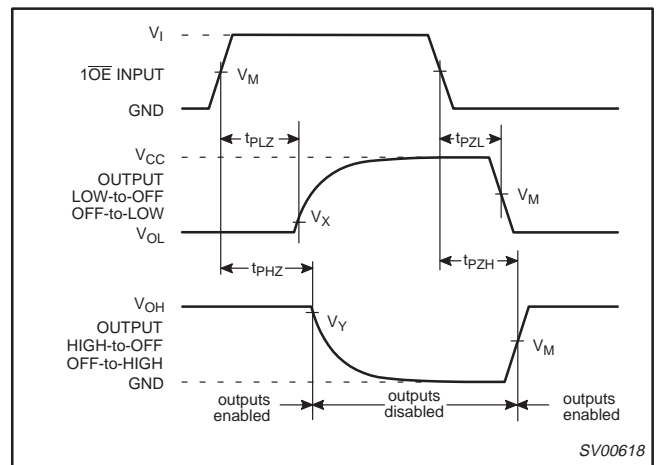


Figure 2. 3-State enable and disable times.

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AC WAVEFORMS (Continued)

$V_M = 1.5\text{ V}$ at $V_{CC} \geq 2.7\text{ V}$; $V_M = 0.5\text{ V} \times V_{CC}$ at $V_{CC} < 2.7\text{ V}$
 $V_X = V_{OL} + 0.3\text{ V}$ at $V_{CC} \geq 2.7\text{ V}$; $V_X = V_{OL} + 0.1\text{ V} \times V_{CC}$ at $V_{CC} < 2.7\text{ V}$
 $V_Y = V_{OH} - 0.3\text{ V}$ at $V_{CC} \geq 2.7\text{ V}$; $V_Y = V_{OH} - 0.1\text{ V} \times V_{CC}$ at $V_{CC} < 2.7\text{ V}$
 V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

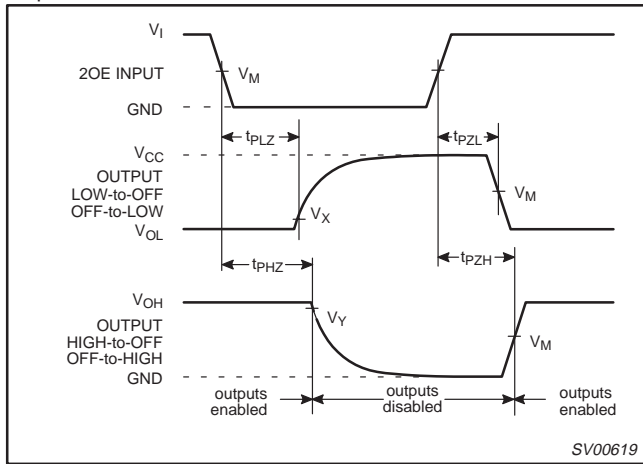


Figure 3. 3-State enable and disable times for input 2OE.

TEST CIRCUIT

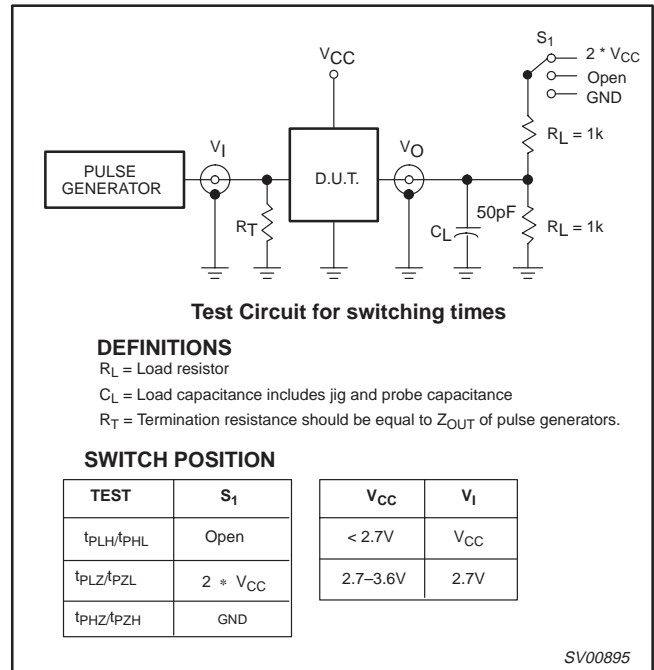


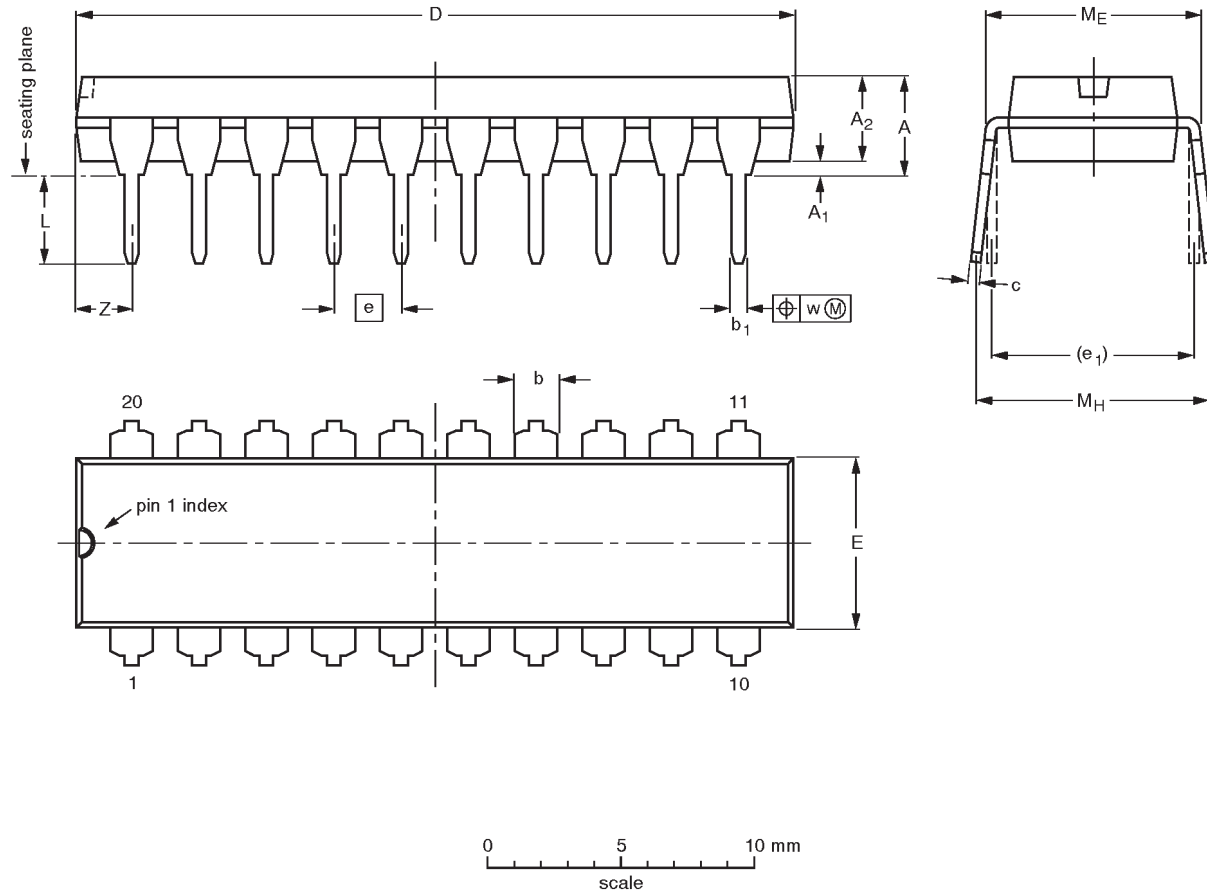
Figure 4. Load circuitry for switching times.

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DIP20: plastic dual in-line package; 20 leads (300 mil)

SOT146-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | c | D ⁽¹⁾ | E ⁽¹⁾ | e | e ₁ | L | M _E | M _H | w | Z ⁽¹⁾ max. |
|--------|--------|---------------------|---------------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|----------------|----------------|-------|-----------------------|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.30 | 0.53 0.38 | 0.36 0.23 | 26.92 26.54 | 6.40 6.22 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 2.0 |
| inches | 0.17 | 0.020 | 0.13 | 0.068 0.051 | 0.021 0.015 | 0.014 0.009 | 1.060 1.045 | 0.25 0.24 | 0.10 | 0.30 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.078 |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

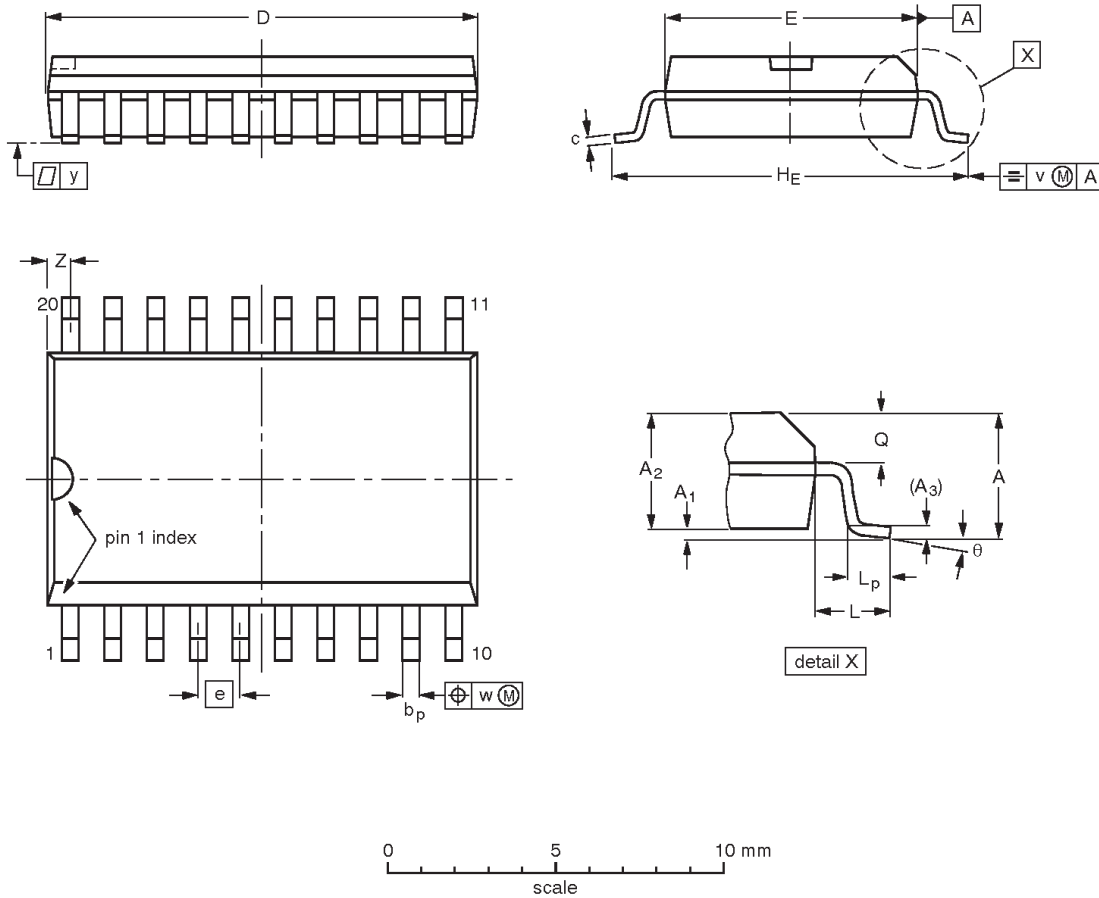
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|-------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT146-1 | | | SC603 | | | 92-11-17 95-05-24 |

Octal buffer/line driver (3-State)

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SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|--------|--------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm | 2.65 | 0.30 0.10 | 2.45 2.25 | 0.25 | 0.49 0.36 | 0.32 0.23 | 13.0 12.6 | 7.6 7.4 | 1.27 | 10.65 10.00 | 1.4 | 1.1 0.4 | 1.1 1.0 | 0.25 | 0.25 | 0.1 | 0.9 0.4 | 8° 0° |
| inches | 0.10 | 0.012 0.004 | 0.096 0.089 | 0.01 | 0.019 0.014 | 0.013 0.009 | 0.51 0.49 | 0.30 0.29 | 0.050 | 0.42 0.39 | 0.055 | 0.043 0.016 | 0.043 0.039 | 0.01 | 0.01 | 0.004 | 0.035 0.016 | |

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT163-1 | 075E04 | MS-013AC | | | | 92-11-17 95-01-24 |

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|----------------|------|----------------|------------|-----|------|-----|------------------|----------|
| mm | 2.0 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 7.4 7.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 0.9 0.5 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT339-1 | | MO-150AE | | | | 93-09-08 95-02-04 |

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|------------|------------------|------------------|------|----------------|-----|----------------|------------|-----|------|-----|------------------|----------|
| mm | 1.10 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 6.6 6.4 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1.0 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.5 0.2 | 8° 0° |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|------------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT360-1 | | MO-153AC | | | | -93-06-16- 95-02-04 |

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DEFINITIONS

| Data Sheet Identification | Product Status | Definition |
|----------------------------------|-------------------------------|--|
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